

# SL2S5302; SL2S5402

ICODE SLIX-S

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Product short data sheet  
PUBLIC

## 1. General description

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The ICODE SLIX-S IC is a dedicated chip for smart label applications with the need for a higher security level, larger memory and/or a product which takes care of the increasing demand for perfect customer privacy. This IC is the third generation of a product family of smart label ICs based on the ISO standards ISO/IEC 15693 ([Ref. 1](#)) and ISO/IEC 18000-3 ([Ref. 4](#)), prolonging a successful story of NXP in the field of vicinity identification systems.

The ICODE system offers the possibility of operating labels simultaneously in the field of the reader antenna (anticollision). It is designed for long range applications.

### 1.1 Contactless energy and data transfer

Whenever connected to a very simple and easy-to-produce type of antenna (as a result of the 13.56 MHz carrier frequency) made out of a few windings printed, winded, etched or punched coil, the ICODE SLIX-S IC can be operated without line of sight up to a distance of 1.5 m (gate width). No battery is needed. When the smart label is positioned in the field of an interrogator antenna, the high speed RF communication interface enables data to be transmitted up to 53 kbit/s.

### 1.2 Anticollision

An intelligent anticollision function enables several tags to operate in the field simultaneously. The anticollision algorithm selects each tag individually and ensures that the execution of a transaction with a selected tag is performed correctly without data corruption resulting from other tags in the field.

### 1.3 Security and privacy aspects

- Unique Identifier (UID):  
The UID cannot be altered and guarantees the uniqueness of each label.
- Password protected memory management (Read/Write access):  
Pages (1 page = 4 blocks of 4 bytes each) can be protected with a password, which ensures that only authorized users get read/write access to the protected parts of the user memory (anti counterfeiting).
- Password protected Label Destroy:  
The 32-bit Destroy password enables an addressed label to be destroyed with the DESTROY SLIX-S command. That status is irreversible and the label will never respond to any command again.
- Password protected Privacy Mode:



The 32-bit Privacy password enables a label to be set to the Privacy mode with the ENABLE PRIVACY command. In this mode the label will not respond to any command except the command GET RANDOM NUMBER, until it next receives the correct Privacy password. This mode is especially designed to meet the increasing demand to take care of the customers privacy.

- Password protected EAS and AFI functionality:

The 32-bit EAS/AFI password enables the addressed label to be set in a mode where the EAS status, the EAS ID and/or the AFI value can only be changed if the correct EAS/AFI password is transmitted to the label within the mentioned commands.

## 2. Features and benefits

### 2.1 ICODE SLIX-S RF interface (ISO/IEC 15693)

- Contactless transmission of data and supply energy (no battery needed)
- Operating distance: up to 1.5 m (depending on antenna geometry)
- Operating frequency: 13.56 MHz (ISM, world-wide licence freely available)
- Fast data transfer: up to 53 kbit/s
- High data integrity: 16-bit CRC, framing
- True anticollision
- Electronic Article Surveillance (EAS)
- Application Family Identifier (AFI) supported
- Data Storage Format Identifier (DSFID)
- ENABLE PRIVACY command with 32-bit Privacy password
- DESTROY SLIX-S command with 32-bit Destroy password
- Additional fast anticollision read
- Write distance equal to read distance

### 2.2 EEPROM

- 2048 bits (2 KB), organized in 64 blocks of 4 bytes each, 4 blocks are summed up to 1 page
- 50 years data retention
- Write endurance of 100000 cycles

### 2.3 Security

- Unique identifier for each device
- Lock mechanism for each user memory block (write protection)
- Lock mechanism for DSFID, AFI, EAS
- Password (32-bit) protected memory management for Read access
- Password (32-bit) protected memory management for Write access
- Password (32-bit) protected Label Destroy
- Password (32-bit) protected Privacy Mode
- Password (32-bit) protected EAS and AFI functionality

### 3. Applications

- Libraries
- Item level tagging in pharmaceutical supply chains
- Counterfeit protection for consumer goods
- Industrial applications
- Asset and document tracking

### 4. Quick reference data

**Table 1. Quick reference data**

Typical ratings are not guaranteed. The values listed are at room temperature.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Wafer EEPROM characteristics</b>						
$t_{\text{ret}}$	retention time	$T_{\text{amb}} \leq 55\text{ °C}$	50	-	-	year
$N_{\text{Endu(W)}}$	write endurance		100000	-	-	cycle
<b>Interface characteristics</b>						
$f_i$	input frequency		[1] 13.553	13.56	13.567	MHz
$C_i$	input capacitance	between LA and LB	[2]			
		SL2S5302FUD	22.3	23.5	24.7	pF
		SL2S5402FUD	92	97	102	pF

[1] Bandwidth limitation ( $\pm 7$  kHz) according to ISM band regulations.

[2] Measured with an HP4285A LCR meter at 13.56 MHz and 2 V RMS.

### 5. Ordering information

**Table 2. Ordering information**

Type number	Package		Version
	Name	Description	
SL2S5302FUD	wafer	sawn, bumped wafer, 120 $\mu\text{m}$ , on film frame carrier, $C_i$ between LA and LB = 23.5 pF (typical)	-
SL2S5402FUD	wafer	sawn, bumped wafer, 120 $\mu\text{m}$ , on film frame carrier, $C_i$ between LA and LB = 97 pF (typical)	-

6. Block diagram

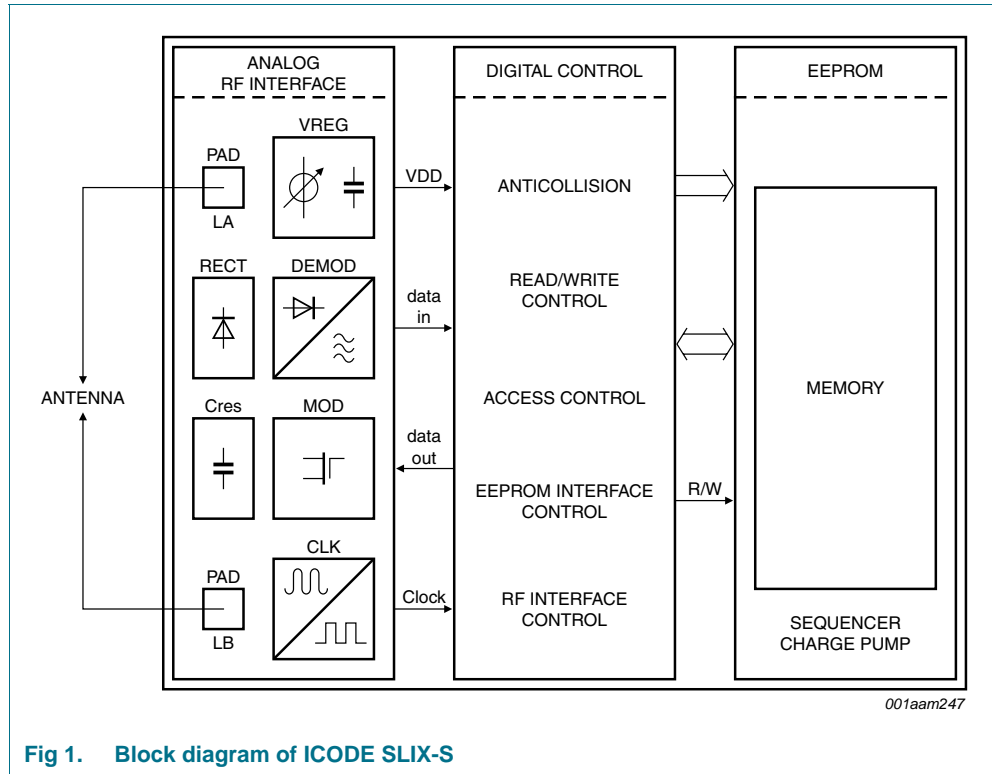


Fig 1. Block diagram of ICODE SLIX-S

## 7. Functional description

### 7.1 Block description

The ICODE SLIX-S IC consists of three major blocks:

- Analog RF interface
- Digital controller
- EEPROM

The analog section provides stable supply voltage and demodulates data received from the reader for processing by the digital section. The analog section's modulation transistor also transmits data back to the reader.

The digital section includes the state machines, processes the protocol and handles communication with the EEPROM.

The label requires no internal power supply. Its contactless interface generates the power supply and the system clock via the resonant circuitry by inductive coupling to the interrogator. The interface also demodulates data that are transmitted from the interrogator to the ICODE Label, and modulates the electromagnetic field for data transmission from the ICODE Label to the interrogator.

Data are stored in a non-volatile memory (EEPROM).

### 7.2 Memory organization

The 2048 bit EEPROM memory is divided into 64 blocks. A block is the smallest access unit. Each block consists of 4 bytes (1 block = 32 bits). 4 blocks are summed up to 1 page for password protection. Bit 0 in each byte represents the least significant bit (LSB) and bit 7 the most significant bit (MSB), respectively.

The memory is divided into 2 parts:

- Configuration area
  - Within this part of the memory all required information is stored, such as UID, write protection, access control information, passwords, AFI and EAS. This memory area cannot be directly accessed.
- User memory
  - Within the 1280 bit memory area the user data are stored. Direct read/write access to this part of the memory is possible depending on the related security and write protection conditions.

Table 3. Memory organization

Page	Block	Byte 0	Byte 1	Byte 2	Byte 3	Description
						Configuration area for internal use
0	0					User memory: 10 pages, 4 blocks each, 4 bytes each, 160 bytes in total.
	1					
	2					
	3					
:	:	:	:	:	:	
9	36					
	37					
	38					
	39					

Blocks 0 to 39 can be addressed with read and write commands only.

### 7.2.1 Unique identifier

The 64-bit unique identifier (UID) is programmed during the production process according to ISO/IEC 15693-3 and cannot be changed afterwards.

The 64 bits are numbered according to ISO/IEC 15693-3 starting with LSB 1 and ending with MSB 64. This is in contrast to the general used bit numbering within a byte.

The TAG type is a part of the UID (bit 41 to 48, next to the manufacturer code which is "04h" for NXP Semiconductors).

The TAG type of the ICODE SLIX-S IC is "02h".

Bit 37 is set to logic 1 for the ICODE SLIX-S IC which indicates that this type supports the password protected AFI feature (not supported by ICODE SLI-S with bit 37 set to logic 0).

Table 4. Unique identifier

MSB						LSB	
64:57	56:49	48:41	40:1				
"E0"	"04"	"02"	IC manufacturer serial number				
UID 7	UID 6	UID 5	UID 4	UID 3	UID 2	UID 1	UID 0

## 8. Limiting values

**Table 5. Limiting values (Wafer)**<sup>[1][2]</sup>

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

Symbol	Parameter	Conditions	Min	Max	Unit
T <sub>stg</sub>	storage temperature		-55	+125	°C
P <sub>tot</sub>	total power dissipation		-	125	mW
T <sub>j</sub>	junction temperature		-40	+85	°C
I <sub>i(max)</sub>	maximum input current	LA to LB; peak	<a href="#">[3]</a> -	±60	mA
I <sub>i</sub>	input current	LA to LB; RMS	-	30	mA
V <sub>ESD</sub>	electrostatic discharge voltage	Human body model	<a href="#">[4]</a> -	±2	kV

- [1] Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions other than those described in the operating conditions and electrical characteristics sections of this specification is not implied.
- [2] This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maxima.
- [3] The voltage between LA and LB is limited by the on-chip voltage limitation circuitry (corresponding to parameter I<sub>i</sub>).
- [4] For ESD measurement, the IC was mounted in a CDIP8 package.

## 9. Abbreviations

Table 6. Abbreviations

Acronym	Description
AFI	Application Family Identifier
CRC	Cyclic Redundancy Check
DSFID	Data Storage Format Identifier
EAS	Electronic Article Surveillance
EEPROM	Electrically Erasable Programmable Read Only Memory
IC	Integrated Circuit
LCR	Inductance, Capacitance, Resistance
LSB	Least Significant Byte/Bit
MSB	Most Significant Byte/Bit
RF	Radio Frequency
UID	Unique Identifier

## 10. References

- [1] **ISO Standard** — ISO/IEC 15693 - Identification cards - Contactless integrated circuit cards - Vicinity cards.
- [2] **ISO Standard** — ISO/IEC 15693-2 -Identification cards - Contactless integrated circuit cards - Vicinity cards - Part 2: Air interface and initialization.
- [3] **ISO Standard** — ISO/IEC 15693-3 -Identification cards - Contactless integrated circuit cards - Vicinity cards - Part 3: Anticollision and transmission protocol.
- [4] **ISO Standard** — ISO/IEC 18000-3 - Information technology - Radio frequency identification for item management - Part 3: Parameters for air interface communications at 13.56 MHz.
- [5] **ISO Standard** — ISO/IEC 7816-6 - Identification cards - Integrated circuit cards - Part 6: Interindustry data elements for interchange.
- [6] **General specification for 8" wafer on UV-tape with electronic fail die marking** — Delivery type description – BU-ID document number: 1093\*\*1.
- [7] **SL2S5302; SL2S5402** — Product data sheet – BU-ID document number: 1921\*\*

1. \*\* ... document version number



11. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
SL2S5302_SL2S5402_SDS v.3.1	20101001	Product short data sheet	-	-

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Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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